

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China







THIS COPY IS PROVIDED ON A RESTRICTED BASIS AND IS NOT TO BE USED IN ANY WAY DETRIMENTAL TO THE INTERESTS OF PANDUIT CORP.

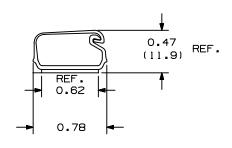


PANDUIT	CUT LENGTH	STATIC LOAD	APPROX. WEIGHT
PART	IN.	b./pc.	bs/100 pcs
NUMBER*	(mm)	(g/pc.)	(g)/100 pcs
LC3-A	0.75 ±0.06	0.22	0.33
	(19.1 ±1.5)	(100)	(150)



NOTES:

- 1. SEE CURRENT PRICE SHEET FOR PART NUMBER SUFFIX DESIGNATION FOR PACKAGE SIZE.
- 2. PART IS DESIGNED TO SUPPORT MAXIMUM WEIGHT ON A CLEAN, DRY, SMOOTH SURFACE. SEE TABLE.



NO WARRANTY, EXPRESSED OR IMPLIED, IS MADE BY PANDUIT WITH RESPECT TO ADHESIVE BOND PERFORMANCE, AMONG OTHER THINGS, THE CONDITIONS UNDER WHICH THESE MOUNTS MAY BE APPLIED AND/OR THE SURFACE TO WHICH THEY MAY BE APPLIED ARE BEYOND PANDUIT'S CONTROL.

R	03/29/9	4 SJSL		INITIAL RELEASE	GB0430BB	R			DATE 03/29/94		GB0430BB	DWG
				000 1000021 02200211200								
				CHANGED CAD FILE NAME FROM GB0430BB_PB_LC3_A_00					DRAWN BY SJSU	MAT'L:	SCALE NONE	
1	6-2-98	MLD		MADE OVERALL HEIGHT DIM A REF. DIM	GB0430BB	1			(.X) ±0.05 [1.3] (.XXX) ±0.010 [0.25]		IN INCHES, THIRD ANGLE PROJECT	CTION.
2	6-29-01	LGG		UPDATED AND ADDED REF.	GB0430BB	2			DIMENSIONAL TOLERANCES ARE:		UNLESS OTHERWISE SPECIFIED,	
									LATCHING CLIP (LC3-A)			
					1				- A TOULING OL 10			
										IDUIT corp.	TINLEY PARK, ILLINO	IS
							CAD FILENWAE/LAYERS G00430BB_PB_LC3_A_02					
							DIMENSIONS IN BRACKETS ARE METRIC [mm]					